## **ADVERTISEMENT FOR BIDS**

Highland County, State of Ohio, through its Board of County Commissioners, will receive bids for 2024 Highland County Chip Seal Program as per specifications, until 9:15 A.M., April 10, 2024 at which time bids will be publicly opened and read aloud at the County Administration Building, 119 Governor Foraker Place, Hillsboro, Ohio 45133.

Anyone interested may download plans and specifications by registering for a free account at <a href="https://bidexpress.com">https://bidexpress.com</a>. Bids are to be electronically submitted through the <a href="https://bidexpress.com">https://bidexpress.com</a> service (fees apply) prior to the above stated time. <a href="https://bidexpress.com">No paper bids will be accepted.</a>

Each bidder is required to furnish with its proposal, a Bid Guaranty and Contract Bond in accordance with Section 153.54 of the Ohio Revised Code. Bid security furnished in Bond form, shall be issued by a Surety Company or Corporation licensed in the State of Ohio to provide said surety.

The owner intends and requires that this project to be completed, no later than September 13, 2024.

All contractors and subcontractors involved with the project will, to the extent practicable, use Ohio Products, materials, services, and labor in the implementation of their project. Additionally, contractor compliance with the equal employment opportunity requirements of Ohio Administrative Code Chapter 123 is required.

Bidders must comply with prevailing wages rates on Public Improvements in Highland County, Ohio as determined by the Ohio Department of Commerce, Bureau of Wage and Hour Administration, 614.644.2239.

The Highland County Board of Commissioners reserves the right to accept the lowest and best bid, reject any and all bids, and to waive any irregularities in bids.

This notice is posted on the Highland County Web site under "Main Menu>Legal Notices" at http://www.co.highland.oh.us

By order of the Board of County Commissioners of Highland County, Ohio.

Mary Remsing, Clerk of Board

Please publish the above advertisement on March 27 and April 3 and send us proof of publication.

Thank you.